Class-E Rectifiers and Power Converters: The Operation of the Class-E Topology as a Power Amplifier and a Rectifier with Very High Conversion Efficiencies

José A. García ¹ and Zoya Popović ²

¹ Department of Communications Engineering, University of Cantabria, 39005 Santander, Spain
² Department of Electrical, Computer and Energy Engineering, University of Colorado, Boulder, CO, 80309, U.S.A.

INTRODUCTION

In the late 70’s, the interest in reducing the value and size of reactive components moved power supply specialists to operate dc-to-dc converters at hundreds of kHz or even MHz frequencies. Passive energy storage (mainly magnetics) dominates the size of power electronics, limiting also its cost, reliability and dynamic response. Motivated by miniaturization and improved control bandwidth, they had to face the frequency-dependent turn-on and turn-off losses associated with the use of rectangular waveforms in the hard-switched topologies of that time. Similar to approaches for RF/microwave power amplifiers (PAs), the introduction of resonant circuits allowed shaping either a sinusoidal voltage or current, with parasitic reactive elements absorbed by the topology in the neighborhood of the switching frequency. The resulting resonant power converters, obtained by cascading a dc-to-ac resonant inverter with a high-frequency ac-to-dc rectifier, first transform the dc input power into controlled ac power, and then convert it back into the desired dc output [1].

This paper provides some historic notes on the operation of the class-E topology, introduced worldwide to the RF/microwave community by Nathan O. Sokal [2], as a power inverter and as a rectifier, with very high conversion efficiencies up to microwave frequencies. Recent research advances and implementations of class-E rectifiers and dc-to-dc converters at UHF and beyond are included. Offering competitive performance in terms of efficiency for RF power recovery, together with a wide bandwidth for low-loss power conversion, their potential for some modern applications is highlighted.
THE CLASS-E POWER INVERTER

A power amplifier is called an inverter in power electronics or related areas [1]. Treated as an energy converter, attention is put into the dc-to-ac conversion efficiency instead of its gain. The input signal is usually the external excitation waveform required to properly drive its switching device. The need for such a signal may be avoided if an oscillator were employed in place of the power amplifier.

Originally conceived as a RF PA in [2], the idea of using a class-E topology for zero voltage (ZVS) and zero voltage derivative switching (ZVDS) in the inverting side of a resonant power converter is attributed to Ronald J. Gutmann [3], a visiting member of Technical Staff at Bell Laboratories in 1979, on leave from Rensselaer Polytechnic Institute. A breadboard dc-to-dc converter, working at 10 MHz, was implemented, using a bipolar-based class-E PA (E10-3) available by that time from Design Automation, Lexington, MA, and a shunt-mounted harmonically tuned rectifier with a silicon Schottky diode (Motorola 1N5822). After the class-E inverter was adjusted to optimize compatibility with the rectifier, an efficiency of 68% was measured and the load regulation capability with frequency control successfully demonstrated.

A deeper insight into class-E power inverter operation was later provided in [4, 5], co-authored by Richard Redl, Béla Molnár and Nat Sokal. Referred to as a class-E converter, a high efficiency about 85% was measured for a 40-W 1.5-MHz implementation of the schematic in Fig. 1a. An International Rectifier IRF 150 MOSFET was employed as the power switch. The experimental converter was designed and built with much less difficulty than had been expected by the authors, suggesting the class-E topology was well-suited to this application. The 100-W 14-MHz transformer-coupled converter in Fig. 1b was demonstrated in 1986 by Redl and Sokal [6], combining a high-power PA and a push-pull rectifier, with an efficiency as high as 87%. Other significant contributions by the same authors may be found in [7, 8].

Many subsequent examples of class-E power inverters may be found in the literature, including variants of the more traditional topology in [2]. That is the case, for instance, of the second-harmonic resonant class-E inverter by Keio University researchers in 1988 [9]. This topology is extended to a continuum of class-E topologies [10], many of which do not require a RF choke coil.
Implementations at HF and VHF bands have become common during the last two decades, where solutions based on the class-$\Phi_2$ inverter [11] are highlighted for their high-efficiency, low-voltage stress and fast transient response performance. In Fig. 2a and Fig. 2b, the schematic and photograph of the inverter in [11] are presented. The resonant leg formed by $L_{MR} - C_{MR}$ imposes a low impedance across the switch at the second harmonic. Together with the rest of components, a quasi-trapezoidal drain-to-source voltage waveform may be achieved with the desired low peak value, while also maintaining near ZVS and ZVDS conditions. A complete 110-MHz class-$\Phi_2$ boost converter is also included in Fig. 2c [12], with a power stage based on a RF LDMOS device and a Schottky rectifier, complemented by a self-oscillating resonant gate driving circuit.
The approach was scaled to microwave frequencies as early as 1999 [13]. A low-power 64% efficient 4.5-GHz microstrip planar converter was demonstrated with a 86% efficient GaAs MESFET class-E PA and a 83% efficient Schottky diode rectifier, with the layout shown in Fig. 3. When feedback coupling equal to the saturated gain of the PA is provided between output and input, the class-E amplifier is converted to an oscillator with conversion efficiency equal to the PAE, and this oscillator was used in [13] together with the rectifier to provide a dc-to-dc converter with no RF inputs, with a slightly reduced efficiency of 57% at 725 mW output power.
**CLASS-E RECTIFIER AND CLASS-E² DC/DC CONVERTER**

Keeping frequency dependent switching loss under control, the soft switching features of the class-E circuit found use not only in high-frequency dc-to-ac power inversion, but also in rectification. The ac-to-dc conversion is the time-reversal dual of dc-to-ac conversion, according to a principle described first in 1990 by Hamill [14].

### A. Time Reversal Duality

Any resonant amplifier may be transformed into a resonant rectifier of the same operating class according to this principle. The rectifier switch voltage and current waveforms are time-reversed versions of the corresponding switch waveforms in the inverter:

\[ v_g(t) = v_i(-t) \]  \hspace{1cm} (1)

and

\[ i_g(t) = -i_i(-t) \]  \hspace{1cm} (2)

leading to a simple relation between their instantaneous powers:

\[ p_g(t) = v_g(t) \cdot i_g(t) = -v_i(-t) \cdot i_i(-t) = -p_i(-t) \]  \hspace{1cm} (3)

Averaged over a cycle, the mean powers in these dual networks have opposite signs, meaning the direction of energy flow is reversed in the rectifier for the desired ac-to-dc conversion.

Based on the above, the class-E inverter circuit in Fig. 4a transforms into the class-E rectifier in Fig. 4b. Analyzed in detail in [15], this is one of the many possible topologies, with rectification of active, or synchronous type, where the gate drive signal of the switching transistor needs to be properly synchronized with the ac excitation. Under 50% duty cycle operation and with the rest of assumptions from [2], the class-E PA in Fig. 4a is seen by its drain voltage supply as a dc resistance \( R_{dc} = 1/(\pi \cdot \omega \cdot C_p) \).

For a DC load of this value at the output of the class-E rectifier, as in Fig. 4b, it presents a resistive input impedance to the ac source equal to the well-known nominal terminating condition, \( R_{dc} = 0.1836/(\omega \cdot C_p) \).
Fig. 4. (a) The class-E inverter or PA, and (b) its transistor-based time-reversed dual, a class-E synchronous rectifier. (c) A basic class-E\(^2\) dc-to-dc converter obtained when cascading (a) and (b). For operation at RF/microwave frequencies, the parallel capacitance \((C_p)\) is generally provided by the device output capacitance \((C_{out})\). Characteristic waveforms for the switch voltage and current are also shown in (a) and (b).

Under appropriate operating conditions, class-E rectifiers may work the same if using diodes or transistors. However, a reduced efficiency may be expected from diode-based topologies at low output voltages, due to the conduction loss in excess determined by the forward voltage drop of a diode. While an active rectifier requires a driver circuit, not only adding complexity but also consuming power, it may offer a unique capability for output voltage regulation [1]. Diode-based rectifier implementations are common at HF and VHF bands, but sufficiently fast Schottky diodes capable of handling high current and voltage levels are rarely available at UHF and higher frequencies, pointing to transistor-based rectifiers as the only choice for high-power RF-to-dc conversion at these bands. The intrinsic drain-to-gate feedback path in the RF FET devices to be employed may also help avoiding the need for the gate driving circuit.

B. Class-E\(^2\) Resonant Converter

The class-E rectifier was conceived for the implementation of the double class-E or class-E\(^2\) resonant converter in [16]. As depicted in Fig. 4c, when cascading the circuits in Fig. 4a and 4b, the rectifier provides the load resistance \(R_{ac}\) required by the inverter. Therefore, both circuits may operate under the desired soft-switching conditions without additional circuit elements. For ideal lossless operation, the output dc voltage \((V_{OUT})\) would equal \(V_{DD}\).
This converter was proposed with frequency-based output voltage control [16], following similar approaches to the pioneer works in [3-5]. The thinned-out method [17], the PWM or on/off and phase-based techniques [18] are among other valid strategies for voltage regulation [19]. Up to the low VHF band, class-E² converter topologies usually incorporate diode-based rectifiers. The need for a gate driving circuit in the inverter side or the minimization of conduction losses in low voltage and high current applications have been addressed in these configurations. Solutions in Fig. 5 have come from the use of an oscillating inverter [20], or of multiphase topologies with interleaved cells [21], respectively.

Fig. 5. Circuit topologies of class-E² converters by Chiba University researchers: (a) 1.55 W converter with oscillating inverter at 2 MHz from [20], and (b) 3.2 W interleaved converter operating at 1 MHz from [21]. (c) Experimental waveforms for the converter in Fig. 5b, also from [21].

While the synchronous operation of an active rectifier requires a second ac source to drive the gate of its transistor, self-synchronous operation is an attractive alternative for RF/microwave implementations. Relying on power coupled from the drain to the gate through the feedback capacitance, \( C_{gd} \), and the use of a highly reflective termination at the gate [22, 23], the transistor may be turned on without a second source and with the same performance as that obtained for the optimum phase and amplitude of the synchronous drive signal, but with higher overall efficiency if the power of the drive signal is taken into account.
RECENT APPLICATIONS AND DESIGN EXAMPLES

There is increased interest in class-E diode or FET-based rectifiers for efficiently recovering power from an incident RF signal in energy harvesting and far-field wireless power transmission applications (WPT). As an example, a recent synchronous rectifier demonstrated in 0.13 μm CMOS technology at 2.4 GHz [24] is intended for wireless sensors that do not require batteries. A photograph of the 850 μm x 870 μm rectifier die is reproduced in Fig. 6a, and the power efficiency and output voltage profiles versus the available power are plotted in Fig. 6b for a load in the optimum conversion range.

![Figure 6a](image1.png) ![Figure 6b](image2.png)

Fig. 6. (a) Class-E synchronous rectifier in [24]. (b) Power efficiency and output voltage as a function of available power at a 250 Ω load (courtesy of Prof. Thomas Johnson, UBC).

Most of the rectifiers reported in the literature are the rectifying stages of the above described double class-E resonant power converter. Class-E\(^2\) topologies with a rectifier wirelessly connected to the inverter are also becoming common, at hundreds of kHz or a few MHz, for implementing inductive or resonant WPT links. While the Wireless Power Consortium (WPC) and the Power Matters Alliance (PMA) WPT standards are based on the inductive coupling method, with a frequency adjustable from 87 to 357 kHz, the Alliance for Wireless Power (A4WP) standard employs the magnetic resonance method, with an operation frequency of 6.78 MHz [25]. In Fig. 7a, an example of tunable class-E\(^2\) converter application at 6.78 MHz is presented [26], aimed at maintaining a high efficiency while also ensuring stable output power under variable operating conditions (different coil relative position and dc load). A comparison of the measured efficiency and output power evolution with load resistance for a coupling factor \((k)\) of 0.3 is presented in Fig. 7b and Fig. 7c for illustration purposes.
Fig. 7. (a) Dynamically controlled class-$E^2$ dc-to-dc converter at 6.78 MHz for WPT [26]. Comparison of (b) efficiency and (c) output power performance versus dc load with $k = 0.3$ for a conventional topology, a converter with fixed input matching network and a tunable converter.

A. Class-E Rectifiers

Two comparative examples of diode- and transistor-based class-E low-power rectifiers, for use in far-field WPT, are described in this section. The class-E rectifier in Fig. 8a from [27] employs an Avago Tech. HSMS-282 Schottky diode. A peak efficiency value of 74% was measured at 23 dBm (Fig. 8b), with a recovered voltage linearly following the input amplitude. When the incident power is reduced, the variation in the input impedance affects the performance. An interesting solution to this limitation may come from the use of a resistance compression network (RCN) and a plurality of similar rectifiers. Resistance compression networks [28] are a special class of matching network that provide reduced impedance variation at the RF input as compared with the rectifier inputs. A schematic and a photograph of a four-way transmission line RCN are included in Fig. 8c and Fig. 8d, respectively [29].
Fig. 8. Diode-based rectifier in [27]: (a) photograph and (b) measured profile. Transmission line RCN in [29]: (c) schematic and (b) photograph (courtesy of Prof. Dave Perreault).

In Fig. 9a, a photograph of a self-synchronous and self-biased rectifier is included, using the VMMK-1218 EpHEMT from Avago Tech. For turning on the device at very low power values, a bootstrap connection of the rectified voltage to the gate terminal is shown in [30]. The gate dc voltage can also be forced to follow the input power with an appropriately dimensioned biasing resistor and the small dc current resulting from rectification in the device gate-to-source junction. Measured results for 915 MHz and 2.45 GHz implementations in Fig. 9b show high peak efficiencies (88% and 77%, respectively), with a reduction of only 10 points for a power range of 20 dB.

Fig. 9. E-pHEMT rectifier [30]: (a) photograph and (b) measured results for (—) 900 MHz and (--) 2.45 GHz implementations.
A promising design methodology for Class-E rectifiers with near resistive input impedance has been recently presented in [31]. Experimentally evaluated with Si Schottky diodes for VHF rectification, this method should translate well to transistor-based topologies at UHF and the lower microwave bands. In [24], an exhaustive performance comparison of recently reported RF rectifier circuits was included. Integrated and discrete rectifiers, following different topologies and based either on diodes or transistors, were studied. Adding the above examples, class-E circuits have proved to offer competitive efficiency figures for RF power recovery.

B. DC-to-DC Converters

Examples of UHF/microwave converters shown in this section include synchronous and self-synchronous rectifiers, as well as an oscillating inverter as in [13] and [20]. The photograph and results in Fig. 10 correspond to a synchronous class-E² converter using CGH60030D GaN transistors from Wolfspeed, designed following the technique in [32]. With a peak of nearly 80%, the efficiency is as high as 75% for 6 dB of power back-off. Conceived to be employed with FM-control as in [3-5], [16], it can be used as an envelope modulator in a supply-modulated efficient transmitter. Very fast dynamic performance was measured, with a large-signal bandwidth of 56.5 MHz and a slew-rate 2.25 V/nS [33], in the state-of-the-art for resonant power converters.

![Die-based GaN HEMT class-E² converter at 1 GHz](image)

Fig. 10. Die-based GaN HEMT class-E² converter at 1 GHz: (a) photograph of the implementation together with (b) measured dynamic performance.

In Fig. 11a, a self-synchronous converter requiring only a single RF input, is presented [23]. Implemented with Qorvo 250-nm GaN HEMT devices around 1.2 GHz, with a resonant dc-isolated coupling network between the PA and rectifier, 75% total efficiency is demonstrated at 5 W (Fig. 11b). An oscillating and self-synchronous dc-to-
dc converter is also successfully demonstrated and tested in [23]. A photograph of this converter is included in Fig. 11c. 80% total efficiency was measured (Fig. 11d), with a linear frequency-based output voltage control available through the gate-to-source biasing voltage of the inverting device [34].

![Photograph of the class-E2 self-synchronous converter at 1.2 GHz](image)

**Fig. 11.** Class-E² self-synchronous converter at 1.2 GHz [23]: (a) photograph and (b) measured output power and efficiency profiles with output DC voltage. Class-E² oscillating and self-synchronous converter at 1 GHz [23]: (c) photograph and (b) measured output power and efficiency profiles with output DC voltage.

The class-E² architecture was also integrated in the Qorvo 150-nm GaN on SiC process at 4.6 GHz in [35], with a decreased efficiency due to the increased losses expected at this frequency for this particular process. Nevertheless, this 2.3mm x 3.8mm integrated converter is fully monolithic with no external magnetic components, Fig. 12. The total efficiency of around 50% indicates that both rectifier and amplifier are operating at efficiencies above 70%.
Fig. 12. Fully integrated class-E$^2$ synchronous dc-to-dc converter at 4.6 GHz [35]. The 3.8mm x 2.3mm GaN-on-SiC die using the Qorvo 150-nm gate process demonstrates a total efficiency above 50% with no external components.

Some of these GaN HEMT based double class-E converters have been integrated with class-E amplifiers [36] for the implementation of polar transmitters. A version with packaged devices from Cree, using PWM or on/off control for the coding of the envelope [19], is presented in Fig. 13a, together with the spectrum resulting from the reproduction of an EDGE signal in Fig. 13b. An average efficiency of 46% was measured. An alternative implementation with dies, also from Cree, and based on FM coding of the envelope, is presented in Fig. 13c. This architecture integrates a converter based in the one of Fig. 10, later improved in [33]. The RFPA, originally designed as class-E amplifier, may be modified to class-J mode for the operation in a hybrid envelope tracking (ET) – envelope elimination and restoration mode (EER). An auxiliary GaN HEMT was added to reduce the sensitivity of the class-E$^2$ converter to load variations. The spectrum of the reproduced 1c-WCDMA signal has been included in Fig. 13d. An average efficiency of 57% was measured in this case.
Fig. 13. Polar transmitter implementations integrating class-E\(^2\) resonant converters: (a) Packaged device version at 770 MHz from [19] together with the (b) reproduced EDGE signal spectrum. (c) Die based architecture at 1 GHz, reproducing a 1c-WCDMA signal in d).

**CONCLUSIONS**

The inherent low-loss operation of the class-E topology, introduced worldwide to the RF/microwave community by Nathan O. Sokal, has found significant applications not only in amplifiers, but also for RF-to-dc and dc-to-dc power conversion [33]. Efficiency values reported for low-power transistor-based class-E rectifiers, designed for RF energy recovery at 915 MHz and 2.45 MHz IMS bands, are close to 90% and 80%, respectively. Interestingly, the synchronous and self-synchronous class-E operation and time-reversal duality of amplifiers and rectifiers extends to all amplifier classes. High-power and efficient rectifiers operating in classes E, C, F, F\(^{-1}\) are demonstrated in the UHF and microwave bands using GaN HEMT hybrid technology [22, 37]. Single-ended single-stage, power combined and two-stage GaN MMIC implementations at X band have also been demonstrated with efficiencies up to 70% [38, 39] at several watts of output power in harmonically-terminated PAs operated as rectifiers, as discussed theoretically in [22].

The integration of inverters (PAs) and rectifiers in double class-E power converters is discussed through several hybrid UHF and MMIC microwave experimental examples. Applications include high efficiency inductive or resonant near-field wireless power transmission links, and fast response dc-to-dc converters. The operation of converters at higher switching frequencies is mainly motivated by the interest in miniaturization and improved control bandwidth. The frequency dependence of gating, switching and magnetic losses imposes significant constraints on this direction [40]. Resonant gate driving and soft switching stand as fundamental techniques to minimize these device...
loss mechanisms, reason why the RF design concepts behind the ZVS and ZVDS class-
E power amplifier have been so attractive for power electronic specialists. Switching
fast enough may also help minimizing or even eliminating magnetic materials [40],
enabling not only PCB but also MMIC integration of the power converter [35].
In table I, a performance comparison of recently reported RF dc-to-dc converters is
included. All of them are research oriented implementations, authors are not aware of
any actual uses of the class-E power converter in products. Although far from being
competitive in terms of conversion efficiency with well stablished kHz topologies, high-
frequency class-E based or derived power converters may provide efficiency values
close to 90% at 110 MHz [12], 80% at 980 MHz [23] and 65% at 4.5 GHz [13]. The
power density may be far from the expected in research oriented hybrid
implementations as [23], but its miniaturization up to the MMIC level has been shown
to be feasible [35]. Wide bandwidth values and slew rates have been reported, in the
state-of-the-art for switching converters. The limitation in the measured efficiency at
UHF and microwave bands may be partially associated to the fact that the employed RF
transistors have not been fabricated for this purpose, but for their use in class-AB
current source power amplifiers. The estimated losses for the 980 MHz converter in [23]
showed that the biggest contributor to the dissipated power was the transistor’s ON-
state resistance. Significant advances in high breakdown technologies, the optimization
of the device layout for soft switching operation and the selection of the most
appropriate architecture and control method [40], may all lead to further improvements.
Table I. Performance Comparison of Recently Reported RF Power Converters

<table>
<thead>
<tr>
<th>Ref.</th>
<th>Freq. (MHz)</th>
<th>$P_{\text{out}}$ (W)</th>
<th>$\eta_{\text{ov}}$ (%)</th>
<th>Technology</th>
<th>Type</th>
<th>$\text{BW}_{\text{in}}$ (MHz)</th>
<th>Size (mm x mm)</th>
</tr>
</thead>
<tbody>
<tr>
<td>[21]</td>
<td>1</td>
<td>3.2</td>
<td>90</td>
<td>MOSFET</td>
<td>Interleaved class-E$^2$</td>
<td>N/R</td>
<td>N/R</td>
</tr>
<tr>
<td>[20]</td>
<td>2</td>
<td>1.55</td>
<td>78.9</td>
<td>MOSFET</td>
<td>Class-E$^2$ (with oscillating inverter)</td>
<td>N/R</td>
<td>N/R</td>
</tr>
<tr>
<td>[41]</td>
<td>20</td>
<td>16</td>
<td>92.5</td>
<td>GaN</td>
<td>Synchronous buck converter</td>
<td>N/R</td>
<td>2 x 2</td>
</tr>
<tr>
<td>[42]</td>
<td>25</td>
<td>68</td>
<td>96.5</td>
<td>GaN</td>
<td>4 phase synchronous buck convert</td>
<td>20</td>
<td>N/R</td>
</tr>
<tr>
<td>[43]</td>
<td>30</td>
<td>220</td>
<td>87.5</td>
<td>MOSFET</td>
<td>Class-Φ$^2$</td>
<td>N/R</td>
<td>N/R</td>
</tr>
<tr>
<td>[44]</td>
<td>100</td>
<td>7</td>
<td>91</td>
<td>GaN</td>
<td>Synchronous buck converter</td>
<td>20</td>
<td>4 x 4</td>
</tr>
<tr>
<td>[12]</td>
<td>110</td>
<td>25</td>
<td>87</td>
<td>LDMOS</td>
<td>Resonant boost conv.</td>
<td>1</td>
<td>27 x 49*</td>
</tr>
<tr>
<td>[45]</td>
<td>233</td>
<td>0.55</td>
<td>82</td>
<td>CMOS</td>
<td>Integrated buck dc–dc converter</td>
<td>N/R</td>
<td>3.5 x 4.5</td>
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<tr>
<td>[41]</td>
<td>400</td>
<td>5</td>
<td>67%</td>
<td>GaN</td>
<td>Synchronous buck converter</td>
<td>N/R</td>
<td>2 x 2</td>
</tr>
<tr>
<td>[19]</td>
<td>780</td>
<td>11.5</td>
<td>72</td>
<td>GaN</td>
<td>Class-E$^2$</td>
<td>11</td>
<td>144 x 88</td>
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<tr>
<td>[23]</td>
<td>980</td>
<td>12.9</td>
<td>79.4</td>
<td>GaN</td>
<td>Class-E$^2$ (no RF inputs required)</td>
<td>32</td>
<td>60 x 77</td>
</tr>
<tr>
<td>[33]</td>
<td>1090</td>
<td>8.5</td>
<td>76.7</td>
<td>GaN</td>
<td>Class-E$^2$ (with self-synchronous rectifier)</td>
<td>56.5</td>
<td>44 x 35</td>
</tr>
<tr>
<td>[23]</td>
<td>1200</td>
<td>5</td>
<td>75</td>
<td>GaN</td>
<td>Class-E$^2$ (with self-synchronous rectifier)</td>
<td>N/R</td>
<td>56 x 60</td>
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<tr>
<td>[13]</td>
<td>4500</td>
<td>0.053</td>
<td>64</td>
<td>GaAs</td>
<td>Class-E (with oscillating inverter)</td>
<td>N/R</td>
<td>140 x 70</td>
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<tr>
<td>[35]</td>
<td>4600</td>
<td>0.6</td>
<td>48</td>
<td>GaN MMIC</td>
<td>Class-E$^2$</td>
<td>N/R</td>
<td>3.8 x 2.5</td>
</tr>
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*As estimated from the photograph. N/R (not reported).

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